



Product Change Notification

Change Notification #: 116957 - 00
Change Title: Intel® Xeon® Gold 5218N Processor, PCN 116957-00, Product Design, Order Code, S-Spec and MM Number Change
Date of Publication: May 29, 2019

Key Characteristics of the Change:

Product Design, Order Code

Forecasted Key Milestones:

Date of First Availability of Post-Conversion Material:	June 3, 2019
Date Customer Must be Ready to Receive Post-Conversion Material:	June 3, 2019

**The date of "First Availability of Post-Conversion Material" as denoted in the milestone table above is the earliest projected date when post-conversion material is expected to be available to start shipping to customers if desired. This date is also a good guideline by which customers should begin switching orders from off the old SKUs onto the new SKUs or be prepared to place a last time buy on the older SKUs.*

***The date of "Customer Must be Ready to Receive Post-Conversion Material" is the projected date customers must be prepared to start receiving the Post-Converted Material. After this date, the Pre-Conversion SKUs will be discontinued and no longer guaranteed. They may be available only on a first come first serve basis, while supply lasts.*

*Please place your last time orders putting in your last time orders in on the older SKUs
Please see your Intel Representative as needed.*

Description of Change to the Customer:

In order to ensure a continuous supply of the Intel® Processors listed in the Products Affected/Intel Ordering Codes table below have shifted to other Intel products.

Description of changes between current and replacement MM#/S-Spec:

- Intel® Xeon® Gold 5218N Processor is being updated to 110W. All other specifications are identical.

New Post-Conversion material master numbers (MM#s) and S-specs are listed in the Products Affected/Intel Ordering Codes table. Pre-conversion product data will not be available to customers after the Last Product Discontinuance Order Date listed in this Product Change Notification.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers, although Intel encourages customers to understand the changes and determine the impact on their applications.

New Post-Conversion MM# and S-Specs processors are already available to order and Intel recommends switching to the new MM# and S-Spec parts for future orders.

Please see the Forecasted Key Milestones table above with its accompanying verbiage**. Customers should be ready to place future orders using the new Order Code (referred to as the Post MM#)

Please contact your Intel Field Sales Representative with any questions, requests or concerns.

Products Affected / Intel Ordering Codes:

Marketing Name	Pre Conversion Product Code	Pre Conversion S-Spec	Pre Conversion MM#	Post Conversion Product Code	Post Conversion S-Spec	Post Conversion MM#
Intel® Xeon® Gold 5218N Processor	CD8069504289900	S RFD9	999DA8	CD8069504384601	S RGLN	999KGL

PCN Revision History:

Date of Revision:

May 29, 2019

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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